

HSP

NOTES:

Current Rating: 3.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T or PBT+30%G.F UL94V-0

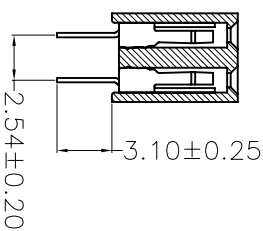
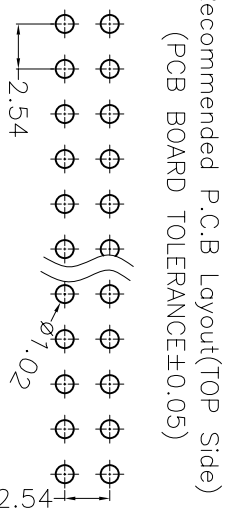
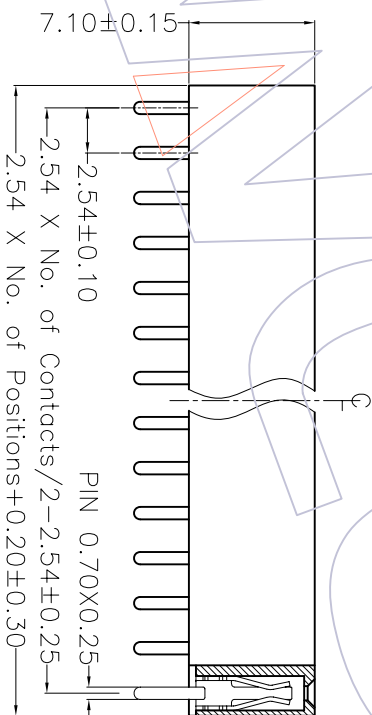
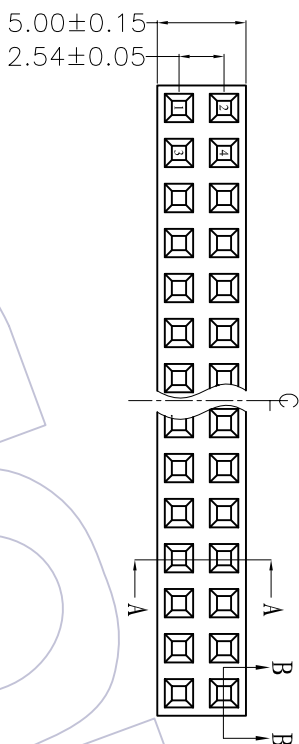
Ordering Information

2171-2 XX S XX X UN T 1

No of Pins per ROW:02-40PIN
 Contact Plating: G=Gold Flash
 G1=5μ"Gold
 G2=5μ"Gold
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S=Gold Flash/Tin
 S1=5μ"Gold/Tin
 S2=5μ"Gold/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Fin

Insulator: A=PBT
 C=PA6T

Packing: T=Tube



SECTION: B-B

SECTION: A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	TITLE:
A0	08/03/12	NEW			X.X ±0.40	DESIGN	08.03.12	2.5:1	2171-2XXSXXXUNT1	FH2.54 DUAL 180° H=7.1
					X.XX ±0.25	CHECK		A4		
					Angle ± .3°	APPROVE		1/1		
					DIM TOL	PROJ.		Customer NO.		

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 WAFER HARDWARE ELECTRONICS CO.,LTD